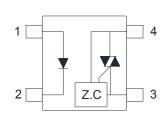


• Description

The KTLP161G series consist of a GaAs infrared emitting diode optically coupled to a monolithic silicon detector performing the function of a zero voltage crossing bilateral TRIAC driver. They are designed for use with a TRIAC in the interface of logic systems to equipment powered from 115 VAC lines, such as solid-state relays, industrial controls, motors, solenoids and consumer appliances, etc.

• Schematic



- 1. Anode
- 2. Cathode
- 3. Main terminal
- 4. Main terminal

Features

- 1. Pb free and RoHS compliant
- 2. 400V peak blocking voltage
- Subminiature type (The volume is smaller than that of our conventional DIP type by as far as 30%)
- 4. Simplifies logic control of 115 VAC power
- 5. Zero voltage crossing
- 6. Isolation voltage between input and output (Viso : 3750Vms)
- 7. MSL class 1
- 8. Agency Approvals :
 - UL Approved (No. E169586): UL1577
 - C-UL Approved (No. E169586)
 - VDE Approved (No. 40009235): DIN EN60747-5-5
 - CQC Approved: GB8898-2011, GB4943.1-2011

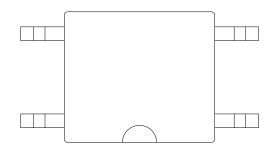
• Applications

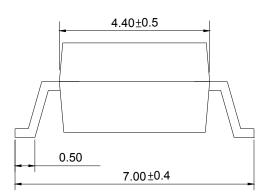
- Solenoid/Valve controls
- Lighting controls
- Static power switches
- AC motor drives
- Temperature controls
- E.M contactors
- AC motor contactors
- Solid state relay
- Programmable controllers

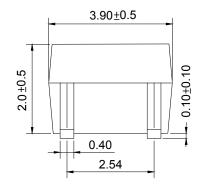


• Outside Dimension

Unit : mm







TOLERANCE : ±0.2mm

• Device Marking



Notes :

cosmo

161G

YWW Y: Year code / W: Week code



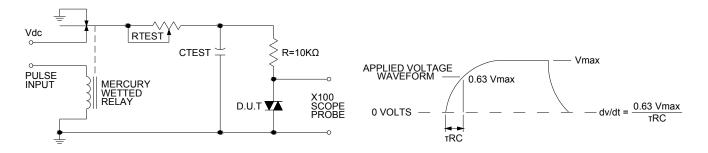
Absol	Absolute Maximum Ratings (Ta=25					
	Parameter	Symbol	Rating	Unit		
Input	Forward current	١ _F	50	mA		
	Peak forward current	I _{FM}	1	А		
	Reverse voltage	V _R	6	V		
	Power dissipation	P _D	70	mW		
	Off-state output terminal voltage	V _{DRM}	400	V _{PEAK}		
Output	On-state R.M.S. current	I _{T(RMS)}	70	mA		
Output	Peak repetitive surge current (PW=10ms.DC 10%)	I _{TSM}	1	А		
	Power dissipation	PD	150	mW		
	Total power dissipation	P _{tot}	200	mW		
	Isolation voltage 1 minute	V _{iso}	3750	Vrms		
	Operating temperature	T _{opr}	-40 to +115	°C		
	Storage temperature	T _{stg}	-50 to +125	°C		
	Soldering temperature 10 seconds	T _{sol}	260	°C		

Electro-ontical Characteristics

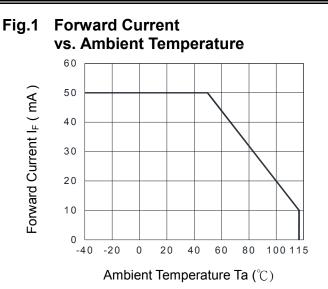
(To-25°C)

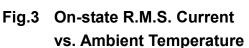
Electro-optical Characteristics							=25()
	Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Input	Forward voltage	V_{F}	I _F =10mA	-	1.2	1.4	V
	Reverse current	I _R	V _R =4V	-	I	10	μA
Output	Peak blocking current	I _{DRM}	V _{DRM} Reted	-	-	1	μA
	On-state voltage	V_{TM}	I _™ =70mA	-	1.8	3	V
Transfer charac- teristics	Holding current	I _H		-	0.1	-	mA
	Critical rate of rise of off-state voltage	dv/dt	V_{DRM} =(1/ $\sqrt{2}$)*Rated	1000	-	-	V/µs
	Inhibit voltage (MT1-MT2 voltage above which device will not trigger)	V _{INH}	I _F = Rated I _{FT}	-	10	20	V
	Leakage in inhibited state	I _{DRM2}	I_F =Rated I_{FT} , Rated V_{DRM} , Off State	-	-	500	μA
	Isolation resistance	R _{iso}	DC500V	5x10 ¹⁰	10 ¹¹	-	Ω
	Minimum trigger current	I _{FT}	Main terminal voltage=3V	-	-	10	mA

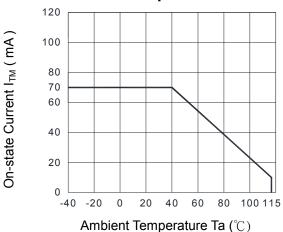
Static dv/dt Test Circuit •



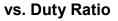












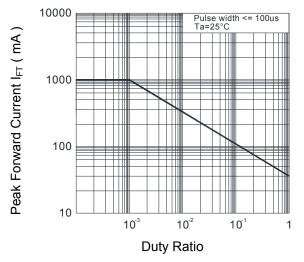
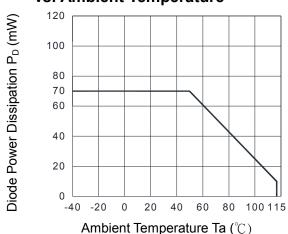
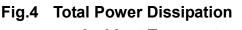


Fig.2 Diode Power Dissipation vs. Ambient Temperature





vs. Ambient Temperature

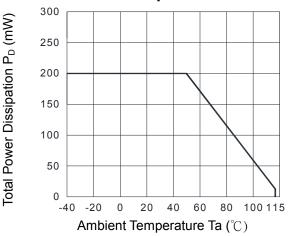


Fig.6 Forward Current

vs. Forward Voltage

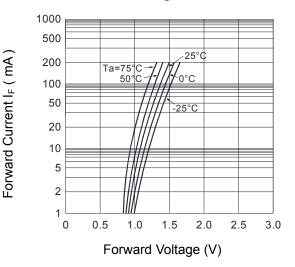
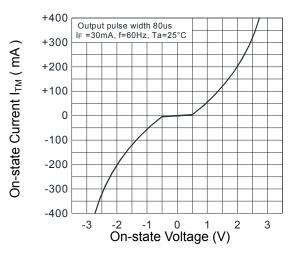
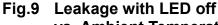




Fig.7 On-state Characteristics





vs. Ambient Temperature

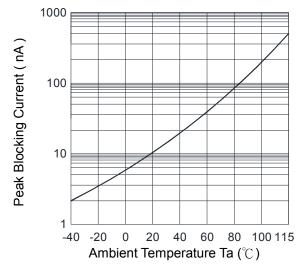


Fig.11 Trigger Current vs. Ambient Temperature

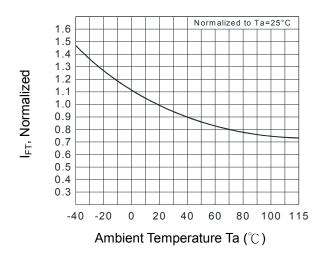


Fig.8 Inhibit Voltage

vs. Ambient Temperature

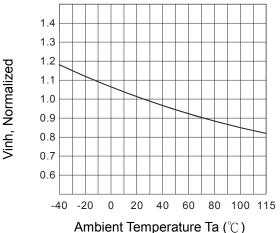
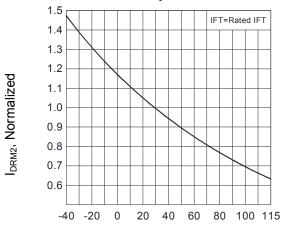


Fig.10 I_{DRM2} ,Leakage in Inhibited State vs. Ambient Temperature



Ambient Temperature Ta (°C)



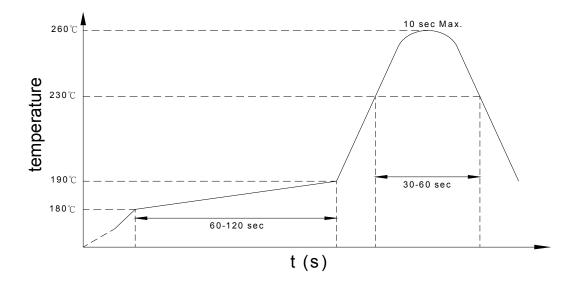
• Recommended Soldering Conditions

(a) Infrared reflow soldering :

Peak reflow soldering :	260 $^\circ\!\!{\rm C}$ or below (package surface temperature)			
Time of peak reflow temperature :	10 sec			
Time of temperature higher than 230 $^\circ\!\mathrm{C}$:	30-60 sec			
Time to preheat temperature from 180~190 $^\circ\!\mathrm{C}$:	60-120 sec			
Time(s) of reflow :	Тwo			
Flux :	Rosin flux containing small amount of chlorine (The			
	flux with a maximum chlorine content of 0.2 Wt% is			
	Time of peak reflow temperature : Time of temperature higher than 230° C : Time to preheat temperature from $180 \sim 190^{\circ}$ C : Time(s) of reflow :			

recommended.)

Recommended Temperature Profile of Infrared Reflow



(b) Wave soldering :

- Temperature : 260°C or below (molten solder temperature)
- Time :

- 10 seconds or less
- Preheating conditions : 120°C or below (package surface temperature)
- Time(s) of reflow :
- Flux :

- One
- Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

(c) Cautions :

- Fluxes : Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.
- Avoid shorting between portion of frame and leads.



• Numbering System

KTLP161G(X)

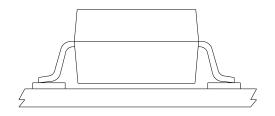
Notes :

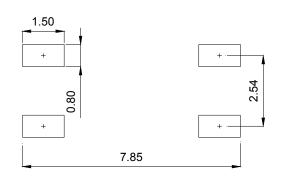
KTLP161G = Part No.

X = Tape and reel option (TLD \cdot TRU)

Option	Description	Packing quantity	
TLD	surface mount type package + TLD tape & reel option	3000 units per reel	
TRU	surface mount type package + TRU tape & reel option	3000 units per reel	

• Recommended Pad Layout for Surface Mount Lead Form

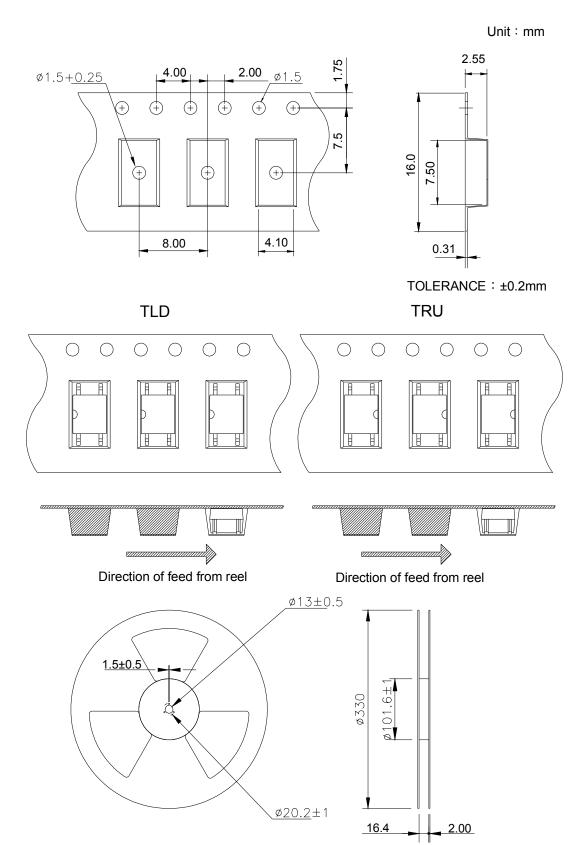




Unit : mm



• 4-pin Mini-Flat TLD/TRU Carrier Tape & Reel





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- e. Electrical application
- f. Measurement equipment
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- h. Telecommunication

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- b. Space application
- c. Telecommunication equipment (trunk lines)
- d. Nuclear power control
- e. Equipment used for automotive vehicles, trains, ships...etc.

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